

R2A20162NS/SA/SP

8-bit 2ch D/A Converter with Buffer

R03DS0016EJ0100

Rev.1.00

2011.09.05

Description

The R2A20162 is an integrated circuit semiconductor of CMOS structure with 2 channels of built in D/A converters with output buffer op-amps. It is the electrical characteristic improvement version of the M62342. Serial data transfer type input can easily be used through a combination of three lines: DI, CLK, and LD. Outputs incorporate buffer op-amps that have a drive capacity of 1 mA or above for both sink source, and can operate over the entire voltage range from almost ground to Vcc (0 to 5V), making peripheral elements unnecessary and enabling configuration of a system with few component parts. Very small SON package is added to lineup. It is suitable for a small mounting and reduces the mounting area.

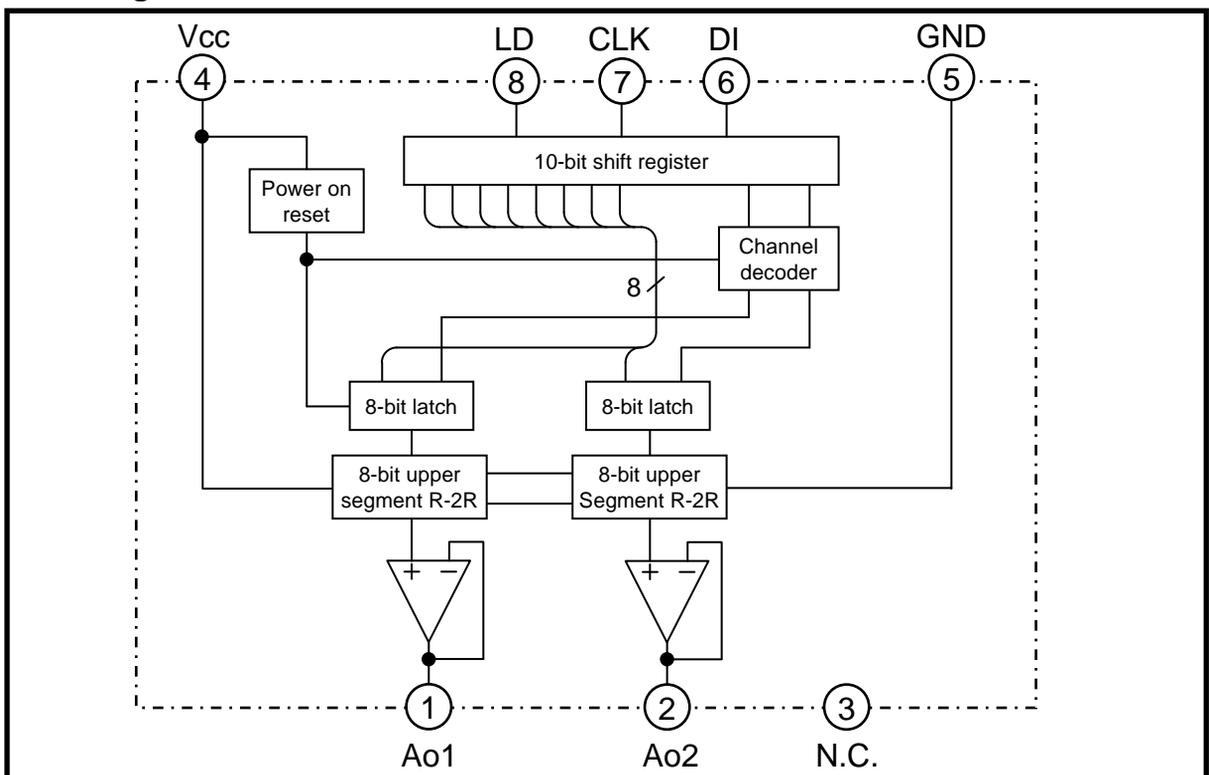
Features

- Guarantee Differential Nonlinearity error : +/- 0.7LSB, Nonlinearity error : +/- 1.0LSB,
- Data transfer format: 10-bit serial data input type by 3 wire (DI, SCK, LD)
- Output buffer op-amps: Operable over entire voltage range from almost ground to Vcc (0 to 5V)
- High output current capacity: +/- 1mA or Higher
- Very small size package line-up: SON-8 (pin pitch: 0.5mm), TSSOP-8 (pin pitch 0.65mm)

Application

- Conversion from digital data to analog control data for home-use and industrial equipment.
- Signal gain control or automatic adjustment of LCD-TV, PDP-TV or LCD display-monitor.
- Blurring correction control or various control of the interchangeable lens of digital camera for self adjustment by combination with microcomputer and EEPROM. (substitution of half fixed resistance)

Block Diagram



Absolute Maximum Ratings

(Ta= +25deg unless otherwise noted)

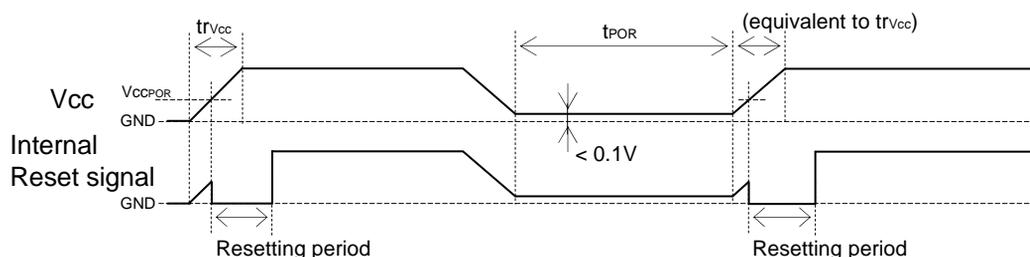
Item	Symbol	Conditions	Ratings	Unit
Supply voltage	Vcc		-0.3 to +6.5	V
Input voltage	Vin		-0.3 to Vcc+0.3 <6.5	V
Output voltage	Vo		-0.3 to Vcc+0.3 <6.5	V
Buffer amplifier output current	IAO	Continuous	-2.0 to +2.0	mA
Power dissipation	Pd	Ta=85deg	270(NS) / 200(SA) / 272(SP)	mW
Thermal derating factor	K theta	Ta>25deg	6.75(NS) / 5.0(SA) / 6.8(SP)	mW/deg
Operating temperature	Topr		-30 to +85	deg
Storage temperature	Tstg		-40 to +125	deg

Electrical Characteristics

(Vcc= +5V +/-10%, GND=0V, Ta= -30 to +85deg unless otherwise noted)

Item	Symbol	Test Conditions	Limits			Unit
			Min.	Typ.	Max.	
Supply voltage	Vcc		2.7	5.0	5.5	V
Supply current	Icc	CLK = 1MHz operation, IAO=0μA, DATA: 6Ah (at maximum current)	0	0.7	2.5	mA
		SDA = SCL = GND, IAO=0μA	0	0.5	1.6	mA
Supply voltage rise-up time *1	trVcc	Vcc=0 to 2.7V	100	—	—	μs
Operating voltage of Internal resetting *1	VCCPOR	Vcc=0 to 2.7V	—	1.5	1.9	V
Time period of re-power on (Power supply OFF → ON) *1	tPOR	Vcc < 0.1V	1	—	—	ms
Input leak current	IILK	VIN= 0 to Vcc	-10	—	10	μA
Input low voltage	VIL		0	—	0.2Vcc	V
Input high voltage	VIH	4.0V < Vcc	0.5Vcc	—	Vcc	V
		Vcc < 4.0V	0.8Vcc	—	Vcc	V
Buffer amplifier output voltage range	VAO	IAO= +/-100μA	0.1	—	Vcc-0.1	V
		IAO= +/-500μA	0.2	—	Vcc-0.2	
Buffer amplifier output drive range	IAO	Upper side saturation voltage = 0.3V Lower side saturation voltage = 0.2V	-1.0	—	1.0	mA
Differential nonlinearity	SDL	Vcc=5.12V (20mV/ LSB), without load (IAO= 0μA)	-0.7	—	0.7	LSB
Nonlinearity	SL		-1.0	—	1.0	LSB
Zero code error	SZERO		-2.0	—	2.0	LSB
Full scale error	SFULL		-2.0	—	2.0	LSB
Output capacitate load	Co		—	—	0.1	μF
Buffer amplifier output impedance	Ro		—	5.0	—	ohm

*1 : When power supply is turned on, internal circuit is initialized by power on reset circuit. But, if re-powered on quickly, initialize is not operate. So, keep the time period of re-powered on (tPOR).

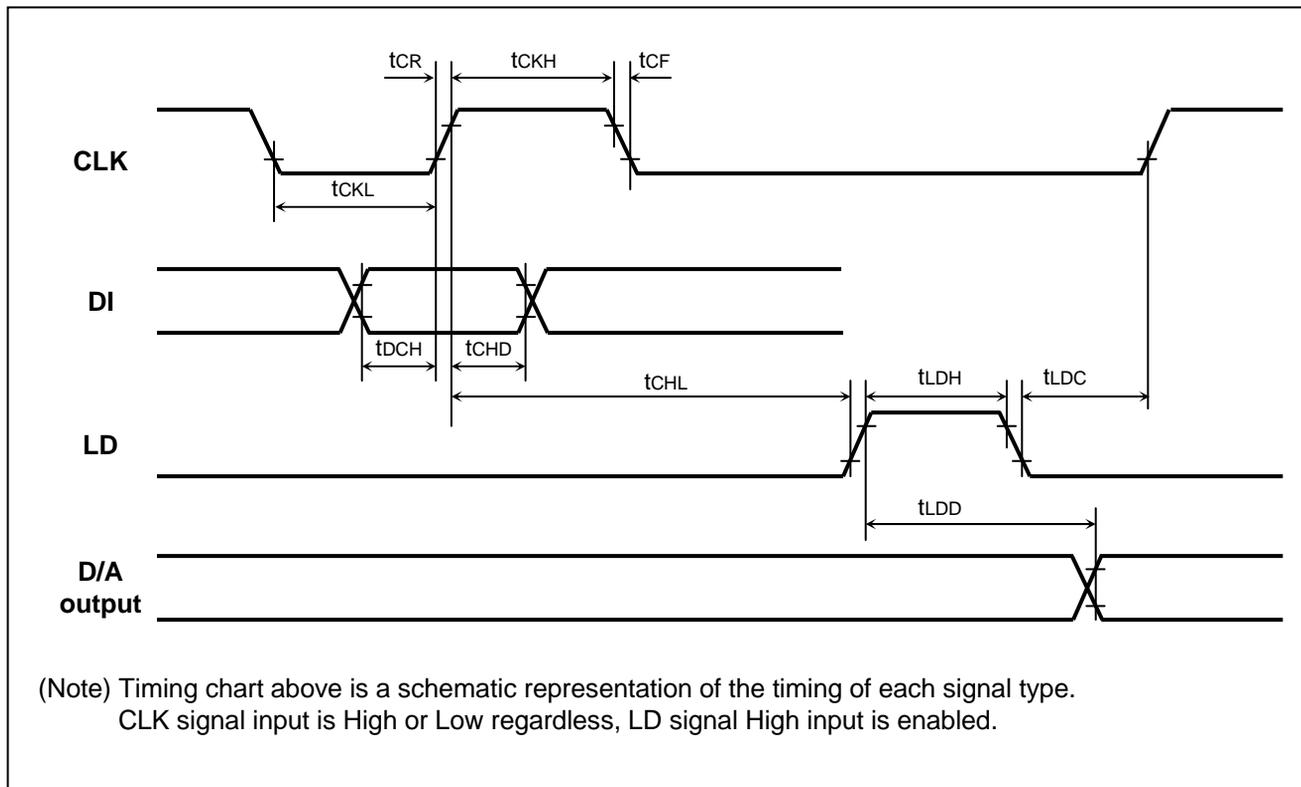


AC Characteristics

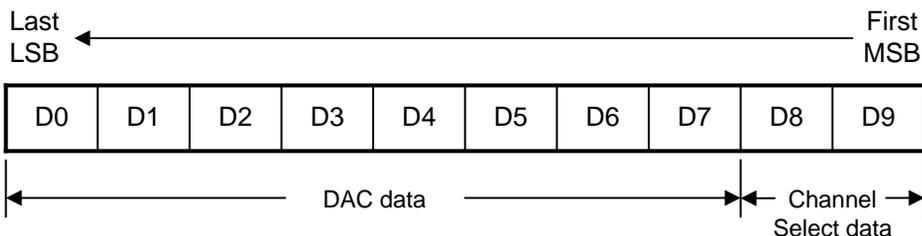
($V_{CC} = +5V \pm 10\text{deg}$, $GND = 0V$, $T_a = -30$ to $+85\text{deg}$ unless otherwise noted)

Item	Symbol	Test Conditions	Limits			Unit
			Min.	Typ.	Max.	
Clock frequency	f _{CLK}		-	1.0	10	MHz
Clock high pulse width	t _{CKH}		40	-	-	ns
Clock low pulse width	t _{CKL}		40	-	-	ns
Clock rise time	t _{CR}		-	-	200	ns
Clock fall time	t _{CF}		-	-	200	ns
Data setup time	t _{DCH}		5	-	-	ns
Data hold time	t _{CHD}		30	-	-	ns
Load setup time	t _{CHL}		40	-	-	ns
Load hold time	t _{LDC}		40	-	-	ns
Load high pulse width	t _{LDH}		40	-	-	ns
D/A output settling time	t _{LDD}	T _a =25deg, C _L <100pF, V _{AO} : 0.5←→4.5V, The time until the output becomes the final value of 1/2 LSB.	-	-	150	μs

Timing Chart



Digital Data Format



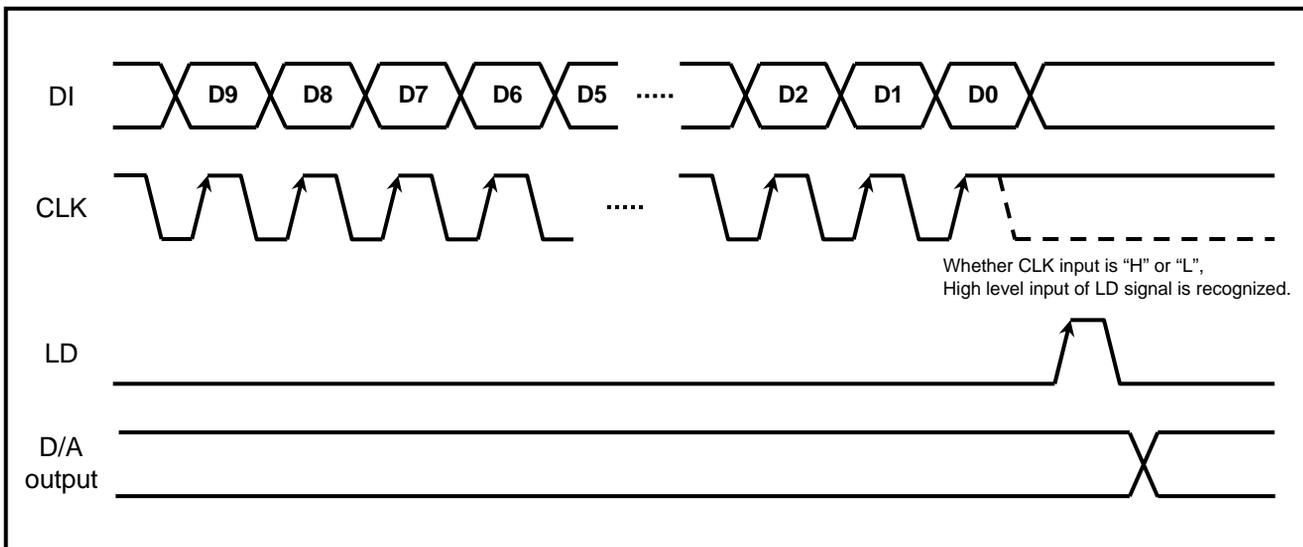
Channel select data

D8	D9	Channel selection
0	0	Ao1 selected
1	0	Ao2 selected
0	1	Don't care
1	1	Don't care

DAC data

D0	D1	D2	D3	D4	D5	D6	D7	DAC output
0	0	0	0	0	0	0	0	$V_{cc}/256 \times 1$
1	0	0	0	0	0	0	0	$V_{cc}/256 \times 2$
0	1	0	0	0	0	0	0	$V_{cc}/256 \times 3$
1	1	0	0	0	0	0	0	$V_{cc}/256 \times 4$
:	:	:	:	:	:	:	:	:
0	1	1	1	1	1	1	1	$V_{cc}/256 \times 255$
1	1	1	1	1	1	1	1	V_{cc}

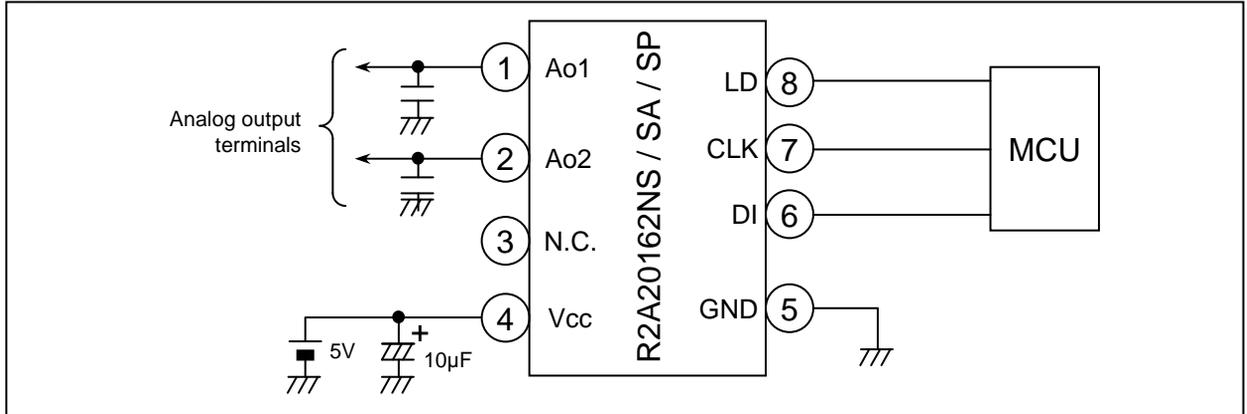
Data timing chart (Model)



Precaution For use

- Supply voltage terminal (Vcc) is also used for D/A converter upper reference voltage setting. If ripple or spike is input this terminal, accuracy of D/A converter is down, So, when use this device, please connect capacitor among Vcc to GND for stable D/A conversion.
- This IC's output amplifier has an advantage to capacitive load, So, it's no problem at device action when connect capacitor (0.1 μ F Max) among output to GND for every noise elimination.

Application Example



Ordering Information

Order part No.	Package Name	Package Code	Package type No.	Packing/Quantity
R2A20162SP	SOP-8	PRSP0008DE-C	SP	Embossed Taping/2,500 pcs.
R2A20162SA	TSSOP-8	RTSP0008JC-B	SA	Embossed Taping/3,000 pcs.
R2A20162NS	SON-8	PWSN0008KA-A	NS	Embossed Taping/5,000 pcs.

Package Dimensions

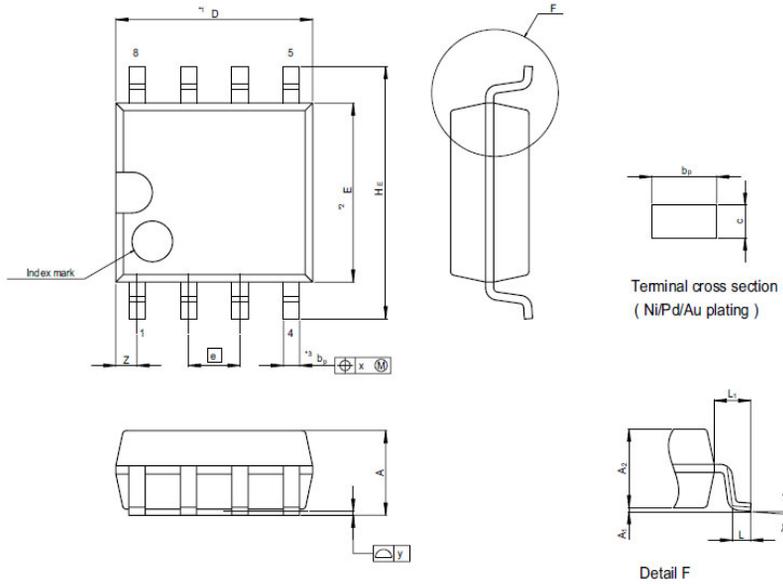
PWSN0008KA-A [NS]

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-HWSON8-2.2x2.2-0.50	PWSN0008KA-A	—	0.011g

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	2.10	2.20	2.30
E	2.10	2.20	2.30
A ₂	—	—	—
A	—	—	0.80
A ₁	0	—	0.05
b	0.18	0.23	0.28
b ₁	—	—	—
Ⓜ	—	0.5	—
L _p	0.20	0.30	0.40
x	—	—	0.1
y	—	—	0.08
y ₁	—	—	0.1
t	—	—	—
H _D	—	—	—
H _E	—	—	—
Z _D	—	—	—
Z _E	—	—	—
c	—	0.20	—
c ₁	—	—	—

PRSP0008DE-C [SP]

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-SOP8-4.4x4.85-1.27	PRSP0008DE-C	—	0.1g

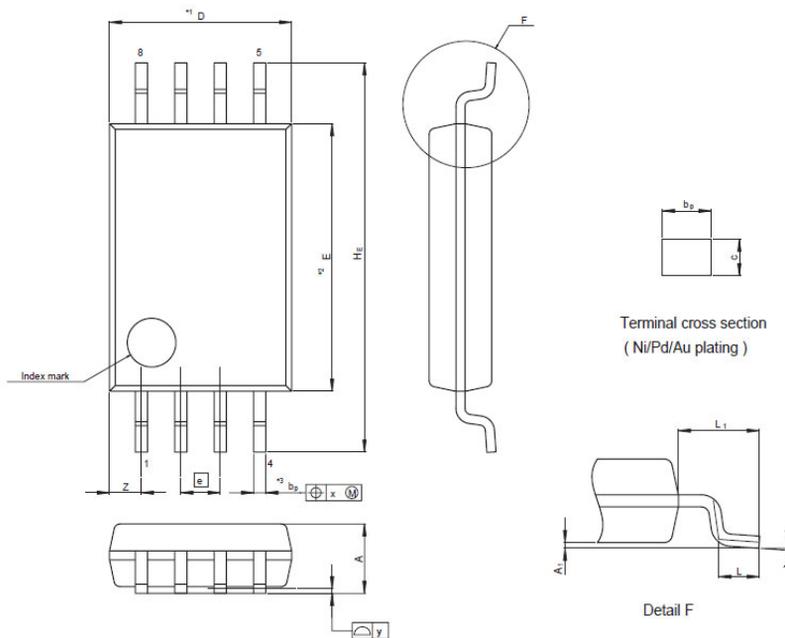


NOTE)
 1. DIMENSIONS**1 (Nom)*AND**2 DO NOT INCLUDE MOLD FLASH.
 2. DIMENSION**3 DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	4.65	4.85	5.05
E	4.2	4.4	4.6
A ₂	—	1.85	—
A ₁	0.00	0.1	0.20
A	—	—	2.03
b _p	0.34	0.4	0.46
b ₁	—	—	—
c	0.15	0.20	0.25
c ₁	—	—	—
θ	0°	—	8°
H _E	5.7	6.2	6.5
Ⓜ	1.12	1.27	1.42
x	—	—	0.12
y	—	—	0.10
Z	—	—	0.75
L	0.25	0.45	0.65
L ₁	—	0.90	—

PTSP0008JC-B [SA]

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TSSOP8-4.4x3-0.65	PTSP0008JC-B	TTP-8DAV	0.034g



NOTE)
 1. DIMENSIONS**1 (Nom)*AND**2 DO NOT INCLUDE MOLD FLASH.
 2. DIMENSION**3 DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	3.00	3.30
E	—	4.40	—
A ₂	—	—	—
A ₁	0.03	0.07	0.10
A	—	—	1.10
b _p	0.15	0.20	0.25
b ₁	—	—	—
c	0.10	0.15	0.20
c ₁	—	—	—
θ	0°	—	8°
H _E	6.20	6.40	6.60
Ⓜ	—	0.65	—
x	—	—	0.13
y	—	—	0.10
Z	—	—	0.805
L	0.40	0.50	0.60
L ₁	—	1.00	—

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